

RS720Q-E11-IM

Great Scalability and High Performance Computing (HPC) **Multi-Node Server with Immersion Cooling Solution**



ASUS RS720Q-E10-IM is the ideal multi-node server powered by 3rd Gen Intel® Xeon Scalable processors, with each node supporting up to 16 DIMM, one PCIe® 4.0 slot, one OCP 3.0 and two M.2, and a total of eight NVMe/SAS/SATA drives.

FEATURE

- Powered by dual-socket 4th Gen Intel Scalable
- Multi-Node Server with Immersion Cooling Solution
- Two PCIe 5.0 x16 slot module per node
- 8 x 2.5" Hot-swap Drive Bays support 8 x NVMe
- 3000W 80 Plus® Titanium power supplies
- Onboard ASUS ASMB11-iKVM
- ASPEED AST2600 controller

4th Gen Intel Xeon Scalable processors

The RS720Q-E11-RS8U is built with the latest Intel® Xeon® Processor Scalable processors with DDR4 Memory up to 4800MHz Family with 16 DDR5 Memory up to 4800MHz, and designed for the demand of high scalability, high density computing, and wide range of existing and emerging workloads.

Immersive Cooling Solution

ASUS Immersion cooling is another highly-effective solution from ASUS. This technique offers more advantages on PUE and encompasses higher-density servers. However, it also demands more space, and may require retooling of the data-center infrastructure. But immersion cooling can control temperatures more rapidly, efficiently and cost-effectively than traditional methods. For users of supercomputers in particular, immersion cooling is the preferred option.

PCIe 5.0 Ready

PCI Express® (PCIe®) 5.0 delivers 16 GT/s bandwidth, which is double the speed of PCIe 4.0, offering lower power consumption, better lane scalability and backwards compatibility.

Enhanced Security

PFR FPGA as the platform Root-of-Trust solution for firmware resiliency Trusted Platform Module 2.0 (TPM 2.0) to secure hardware through integrated cryptographic keys and offer regular firmware update for vulnerabilities.



Environment

RS720Q-E Processor Support		2 x Socket D. (ICA 1677) per Node	SPECIFICATION
		2 x Socket P+ (LGA 4677) per Node	
		Dual 4th Gen Intel [®] Xeon [®] processor Scalable fami	ly (Up to 350W)
Core Logic		Intel [®] C741 PCH	
Memory	Total Slots	16 (8-channel per CPU, 8 DIMM per CPU)	
	Capacity	Maximum up to 8192GB per Node	
	Memory Type	DDR5 4800 RDIMM/RDIMM 3DS (1DIMM per Chann 512GB, 256GB, 128GB Intel® Optane TM persistent m *Refer to Asus server AVL for the latest update	
	Memory Size	64GB, 32GB, 16GB RDIMM 256GB, 128GB RDIMM 3DS * Refer to www.asus.com/support for more informa	tion
Expansion Slots	Total PCI/PCI-X/PCI-E/PIKE Slots	Per Node:	
	Slot Type	2 x PCI-E x16 (Gen5 x16 link), HHHL (CPU1) 2 x M.2 PICe Gen4 x4 link or SATA (CPU1)	
Disk Controller	NVMe Controller	Per Node: Intel® VROC (Support RAID 0, 1) - 2 x NVMe ports	
torage Bays	I = internal A or S will be hot-swappable	8 x 2.5" Hot-swap Storage Bays (NVMe Supported)	
letworking	LAN	Per Node: 2 x Intel X710-AT2 Gigabit LAN Controller 1 x Management Port	
iraphic	VGA	Aspeed AST2600 64MB	
ront I/O Ports		N/A	
Rear I/O Ports		Per Node: 2 x USB 3.1 Ports 1 x VGA Port 1 x RJ-45 GbE LAN Ports 1 x RJ-45 Management Port	
Switch/LED		Per Node: Rear: 1 x Power Switch/LED 1 x Q-Code/Port 80 LED Front: 1 x Power Switch/LED 1 x Location Switch/LED 1 x Message LED 2 x LAN LED	
OS Support		Please find the latest OS support from http://www.a	asus.com/
lanagement	Software	ASUS Control Center (Classic)	
olution	Out of Band Remote Management	On-Board ASM10-iKVM for KVM-over-IP	
Dimension		735mm x 446mm x 88mm (2U) 28.94" x 17.57" x 3.46"	
Net Weight Kg (CPU, DRAM & HDD not included)		25.10 Kg	
Gross Weight Kg (CPU, DRAM & HDD not included, Packing included)		31.70 Kg	
Power Supply (following different configuration by region)		1+1 Redundant 3000W 80 PLUS Titanium Power Sup Rating: 220-240 Vac, 15.5A (x2), 50-60Hz, Class I	pply
Environment			0°C ~ 40°C

Coolant flow rate (per 2U server system): At least 12 LPM * Evaluated using Noah® 3000A coolant

Inlet coolant temperature (per 2U server system): $20^{\circ}C \sim 40^{\circ}C$